



evissaP RoHS Statement Nov. 2015

Reference:

1) Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003

2) Directive 2003/11/EC of the European Parliament of Council of 6 February 2003

3) Commission Decision of 18 August 2005 amending Directive 2002/95/EC (2005/618/EC)

In evissaP's ongoing effort to supply superior quality products to the Microwave and RF community, as well as to comply with the European Parliament Directive 2002/95/EC, evissaP offers the following explanation of its RoHS (Restriction of Hazardous Substances) Compliance Program.

Background:

Of the 6 substances referred to in the Directives, evissaP historically has only introduced and used "lead solder alloys" in its assemblies. evissaP has not intentionally added mercury (Hg), cadmium (Cd), hexavalent chromium (CrVI), polybrominated biphenyls (PBB) or polybrominated diphenyl ethers (PBDE) to its products. In addition, evissaP does not have plans to introduce any of the aforementioned 5 substances into its future products.

Procured Material and Plating:

To the best of our knowledge, none of our suppliers use mercury (Hg), cadmium (Cd), hexavalent chromium (CrVI), polybrominated biphenyls (PBB) or polybrominated diphenyl ethers (PBDE) in their products.

evissaP Inc's definition of RoHS and Lead Free Products:

For evissaP purchased product and services, evissaP relies on supplier statements and/or supplier certification of RoHS compliant product. evissaP considers RoHS compliant product being product having a maximum concentration value of 0.1% by weight in homogeneous materials for lead (Pb), mercury (Hg), hexavalent chromium (CrVI), polybrominated biphenyls (PBB) and polybrominated diphenyl ethers (PBDE) and of 0.1% maximum by weight in homogeneous materials for cadmium (Cd) except as allowed by Directive 2002/95/EC ANNEX titled "Applications of lead, mercury, cadmium and hexavalent chromium, which are exempted from the requirements of Article 4(1)". evissaP certifies that it does not intentionally add any substances, or use materials of its own manufacturer, that would cause non-compliance.



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Connector Material:

Consistent with the ANNEX in Directive 2002/95/EC of the European Parliament and of the Council of 7 January 2003, evissaP shall specify its connectors be manufactured from a copper alloy (e.g. brass) having < 4% lead by weight, steel having < 0.35% lead by weight or aluminum having < 0.4% by weight. If connectors are made from material other than aforementioned, material shall meet a maximum of 0.1% Pb by weight in homogeneous material.

Solders used in Assemblies:

Solders shall meet requirements of Directive 2002/95/EC and its ANNEX. Examples of solders follow:
Lead Free Solders: SnAgCu; SnCu and 100% tin

Specifying and Ordering evissaP Inc. RoHS and Lead Free Products:

For Custom Products, RoHS and Lead Free products are designated by a "LF" suffix on the Part Number.

Part Number example: ePCBL-H0605LF

For Standard Products, RoHS and Lead Free Products are designated by an "R" (vs. an "S") prior to the "dash" in the Part Number before the length designator. Part Number example: eP5001R-10.5

Notification:

evissaP will make all reasonable attempts to notify customers of changes to raw materials, procured materials, or processes that may cause product to be non-compliant as evissaP is made aware of such information. Please note that evissaP and its suppliers do not analyze its products for substances not purposely added. Trace amounts of any chemical and substance might be found as impurities in any product.

About evissaP, Inc.

evissaP, Inc. is the one of the world's leading manufacturer of high performance products such as cable assemblies, adapters, connectors for radio frequency (RF) and microwave applications. We work closely with our customers to accelerate the pace of innovation and to create breakthrough and timely solutions that are ahead of what's possible. evissaP is driving a more innovative and connected world for the future.

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